Renesas Electronics Corporation COSMO Co., Ltd.

PCB stackup

PCB NAME	ET-D720201-0014	material	Hitachi Chemical CORE [MCL-BE-67G(H)] / PP [GEA-67BE(H)HAHJ]
PCB NUMBER			OOKE [MOL-DE-070(H)] 7 11 [OEK-07DE(H)HAND]
# of layer	4	Thickness	$1.6 \pm 0.15(0.063 \pm 0.006)$

PCB stackup							
Layer		Copper Thickness	PCB stackup				
1	Тор	0.018(0.00071)	~~~~~~	PP	0.1(0.0039)		
2	GND	0.035(0.00138)	-	CORE	1.2(0.0472)		
3	Power/GND	0.035(0.00138)		PP	0.1(0.0039)		
4	Bottom	0.018(0.00071)			0.1(0.0003)		

Remarks:

- Minimum Trace width/Space 0.15/0.12 (0.0059/0.0047)
- Minimum VIA-Size Hole Diameter 0.3(0.012) / Round Diameter 0.6(0.024)
- Impedance control
 - PCIe 90 -differential Trace width 0.15(0.0059) / Space 0.12(0.0047)
 - USB 90 -differential Trace width 0.15(0.0059) / Space 0.12(0.0047)
- Copper plating thickness 0.025(0.000984)
- Gilding plating thickness Au: 0.001(0.00003937) Ni: $0.002 \sim 0.006(0.00007874 \sim 0.0002362)$ Board Edge Terminal only

All linear dimensions are in millimeters(inches).

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